POWERTIP TECH. CORP.

MATLOG

SPECIFICATIONS

CUSTOMER	:	PTC
SAMPLE CODE	:	SH480272T005-IBA03
MASS PRODUCTION CODE	:	PH480272T005-IBA03
SAMPLE VERSION	:	01
SPECIFICATIONS EDITION	:	002
DRAWING NO. (Ver.)	:	JLMD-PH480272T005-IBA03_002
PACKAGING NO. (Ver.)	:	JPKG-PH480272T005-IBA03_001

Customer Approved

Date:

Approved	Checked	Designer
閆偉	劉進	徐明菲

□ Preliminary specification for design input

■ Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
01/23/2019	01	001	New Drawing	-	徐明菲
04/09/2019	01	002	New Sample	-	徐明菲

Total: 30 Pages

Contents

Note: For detailed information please refer to IC data sheet:Sitronix--- ST7257

1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	480 * 3 (RGB) * 272 Dots
LCD Type	a-Si TFT , Normally white, Transmissive type
Screen size(inch)	4.3 inch
Viewing Direction	6 O'clock
Color configuration	RGB-Strip
Interface	Digital 24-bits RGB
Other(controller/driver IC)	ST7257
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website : http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	105.5(W) x 67.2 (L) x 3.57(H)	mm
Viewing Area	96.64(W) x 55.456 (L)	mm
Active Area	95.04 (W) * 53.856 (L)	mm

Note : For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDDIO	GND=0	-0.3	+4.6	V
Operating Temperature	T_{OP}	-	-20	+70	°C
Storage Temperature	T_{ST}	-	-30	+80	°C
Storage Humidity	H_D	Ta ≦ 60 °C	-	90	%RH

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power supply	VDDIO	-	3.0	3.3	3.6	V
	VGH	-	13	15	17.5	V
	VGL	-	-11.5	-10	-7	V
“H” Input Voltage	VIH	-	0.7* VDDIO	-	VDDIO	V
“L” Input Voltage	VIL	-	GND	-	0.3* VDDIO	V
“H” Output Voltage	VOH	-	VDDIO -0.4	-	VDDIO	V
“L” Output Voltage	VOL	-	GND	-	GND +0.4	V
Supply Current	IDD	VDDIO=3.3V	-	25	40	mA

1.5 Optical Characteristics

TFT LCD Module VDDIO= 3.3 V, Ta=25°C

Item		Symbol	Condition	Min.	Typ.	Max.	unit	-
Response time	Tr+Tf	25℃	-	-	36	54	ms	-
Viewing angle	Top	θY+	CR ≥ 10	-	60	-	Deg.	Note 4
	Bottom	θY-		-	60	-		
	Left	θX-		-	60	-		
	Right	θX+		-	60	-		
Contrast ratio		CR	IF= 20mA	500	600	-	-	Note 3
Color of CIE Coordinate （B/L & LCD）	White	X		0.26	0.31	0.36	-	Note1
		Y		0.29	0.34	0.39		
	Red	X		0.55	0.60	0.65		
		Y		0.31	0.36	0.41		
	Green	X		0.29	0.34	0.39		
		Y		0.55	0.60	0.65		
	Blue	X		0.10	0.15	0.20		
		Y		0.04	0.09	0.14		
Average Brightness Pattern=white display (B/L & LCD)*1		IV	IF= 20mA	450	550	-	cd/m2	Note1
Uniformity (B/L & LCD)*2		ΔB	IF= 20mA	70	-	-	%	Note1

Note 1:

*1：△B=B(min) / B(max) * 100%

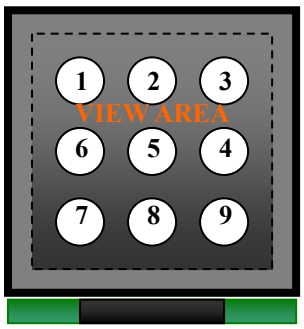
*2：Measurement Condition for Optical Characteristics:

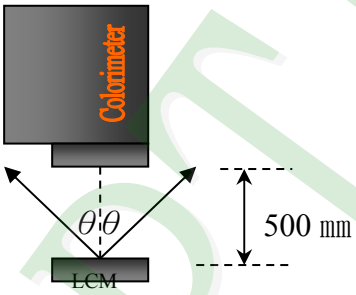
a：Environment: 25℃±5℃ / 60±20%R.H，no wind，dark room below 10 Lux at typical lamp current and typical operating frequency.

b：Measurement Distance: 500 ± 50 ㎜ ，(θ= 0°)

c：Equipment: TOPCON BM-7 fast，(field 1°)，after 10 minutes operation.

d：The uncertainty of the C.I.E coordinate measurement ±0.01，Average Brightness ± 4%





Colorimeter=BM-7 fast

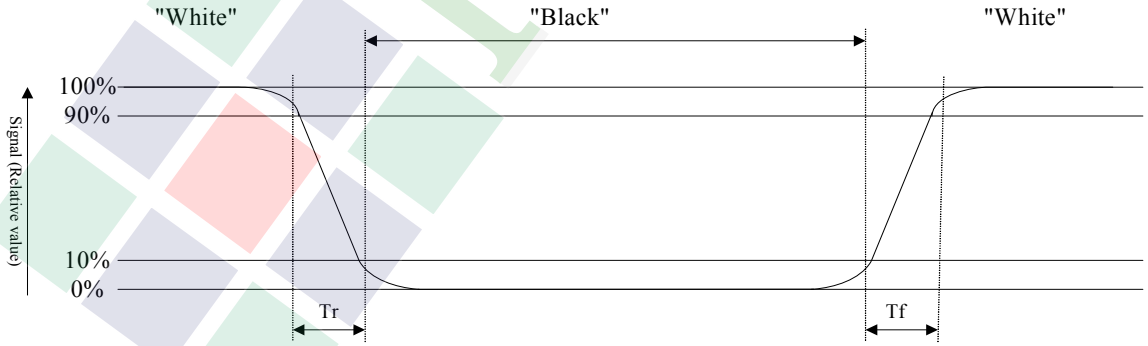
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

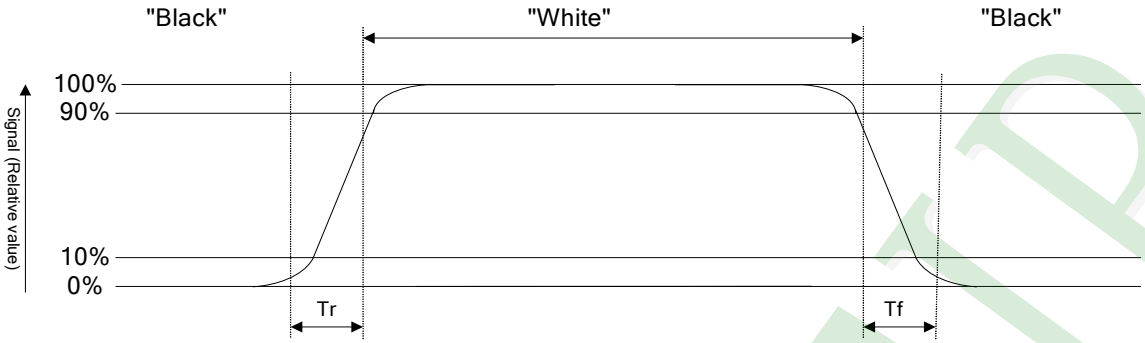
The output signals of photo detector are measured when the input signals are changed from “black” to “white”(falling time) and from “white” to “black”(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:

Normally White



Normally Black



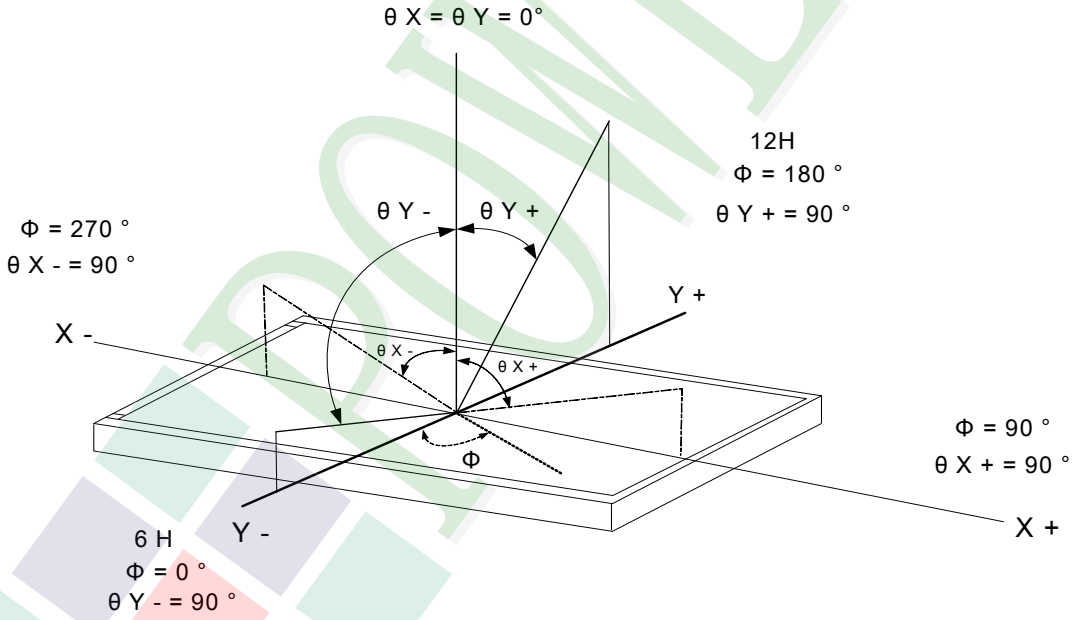
Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at “White” state}}{\text{Photo detector output when LCD is at “Black” state}}$$

Note4: Definition of viewing angle:

Refer to figure as below:



1.6 Backlight Characteristics

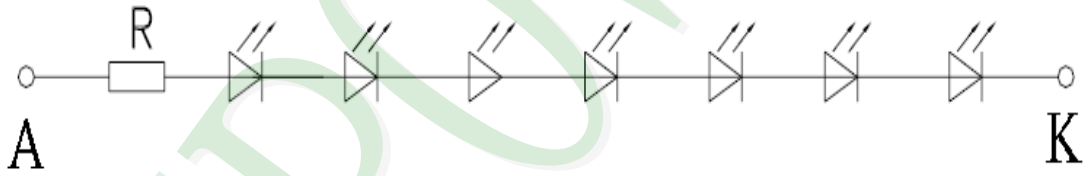
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	Ta =25℃	-	30	mA
LED Reverse Voltage (Each LED)	VR	Ta =25℃	-	5.0	V
Power Dissipation	PD	Ta =25℃	-	490	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF= 20mA	19.6	22.8	24.5	V
Average Brightness (Without LCD &T/P)	IV		8500	9350	-	cd/m^2
CIE Color Coordinate (Without LCD &T/P)	X		0.26	0.30	0.33	-
	Y		0.26	0.30	0.33	
Color	White					

Circuit diagram：



Other Description

Item	Conditions	Description
Life Time	Ta =25℃ IF= 20 mA	20000 hrs

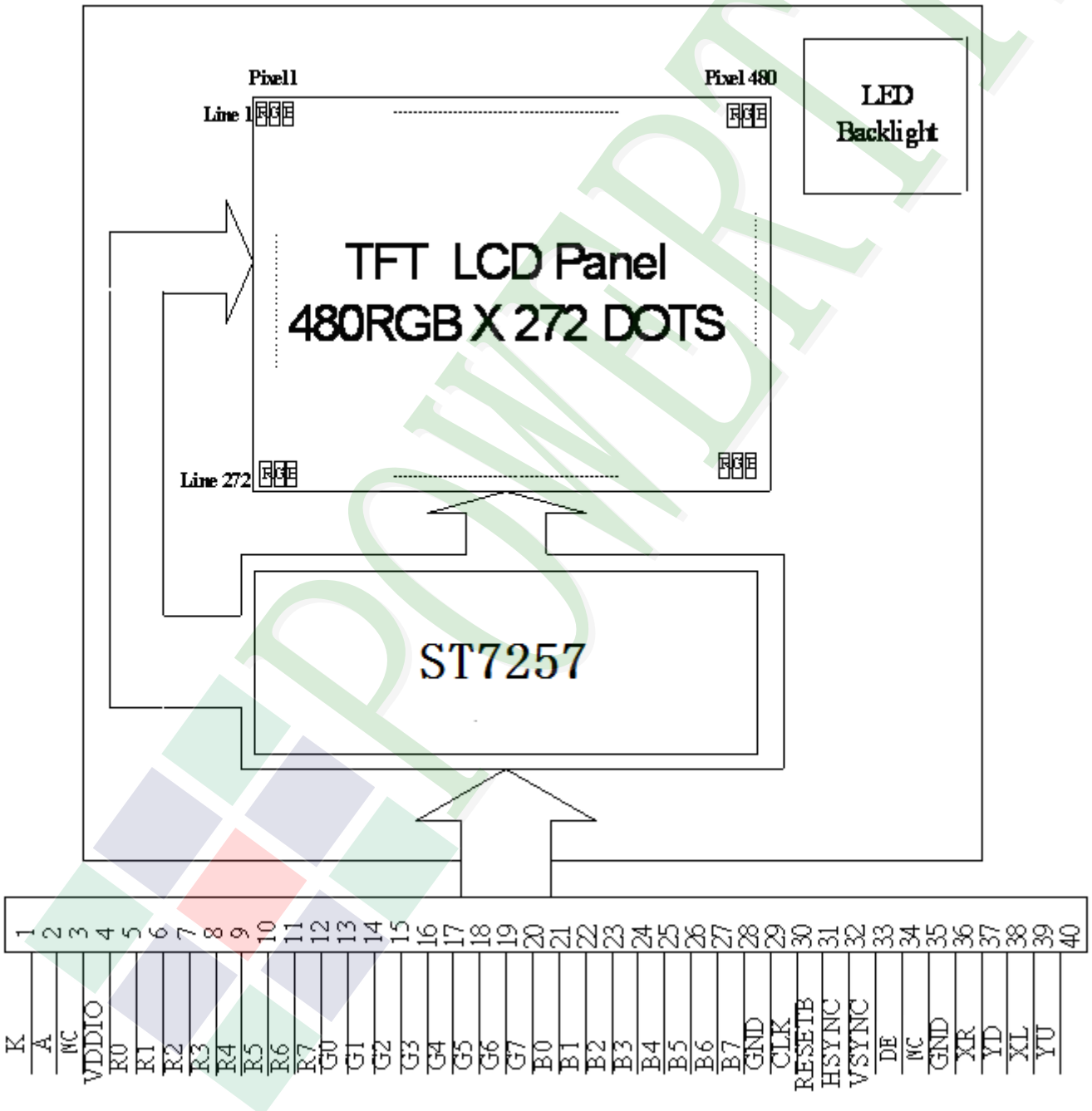
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



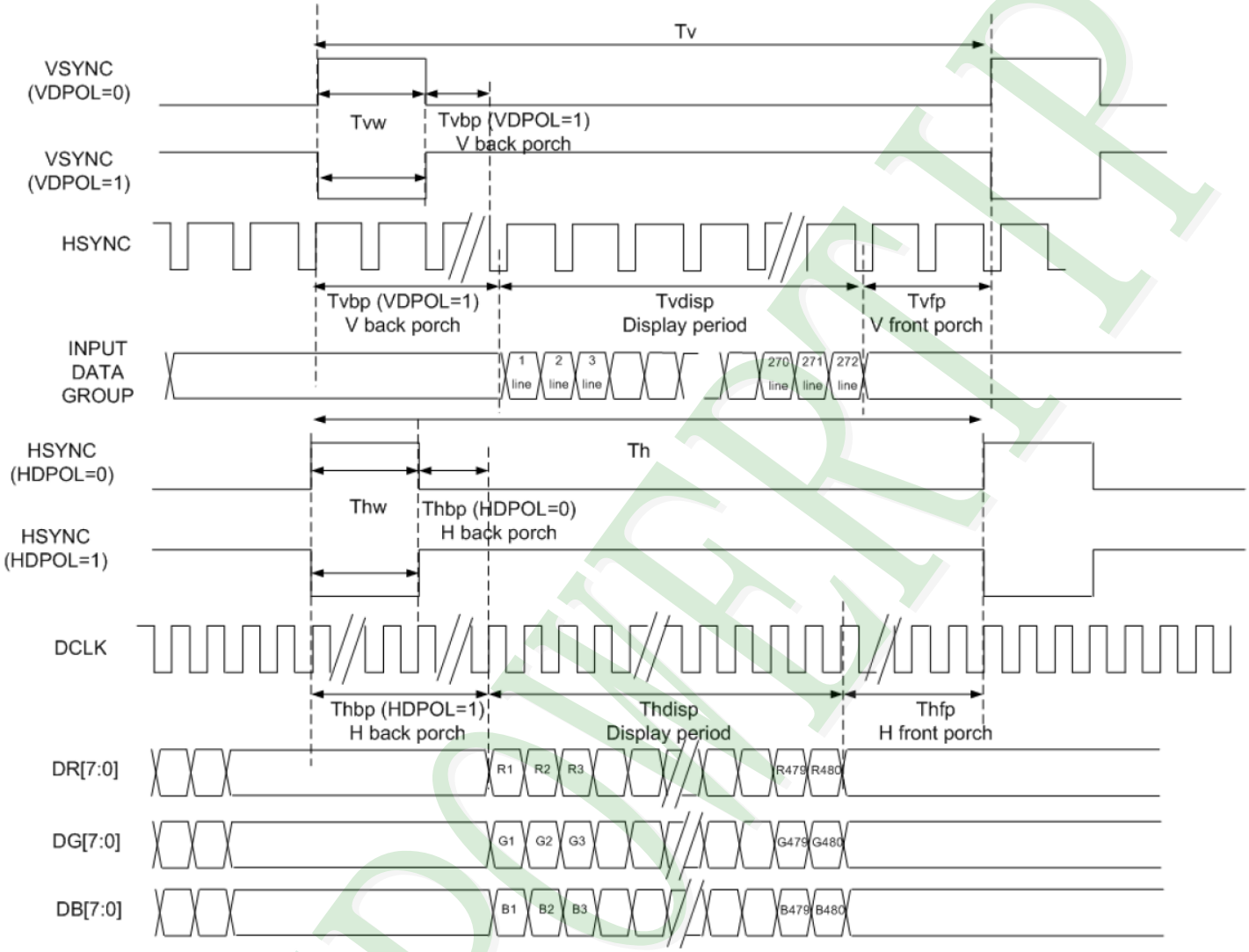
2.2 Interface Pin Description

Pin No.	Symbol	Function
1	K	Power supply for LED Backlight cathode input
2	A	Power supply for LED Backlight anode input
3	NC	Not Connect.
4	VDDIO	Digital power
5	R0	Red data bit 0
6	R1	Red data bit 1
7	R2	Red data bit 2
8	R3	Red data bit 3
9	R4	Red data bit 4
10	R5	Red data bit 5
11	R6	Red data bit 6
12	R7	Red data bit 7
13	G0	Green data bit 0
14	G1	Green data bit 1
15	G2	Green data bit 2
16	G3	Green data bit 3
17	G4	Green data bit 4
18	G5	Green data bit 5
19	G6	Green data bit 6
20	G7	Green data bit 7

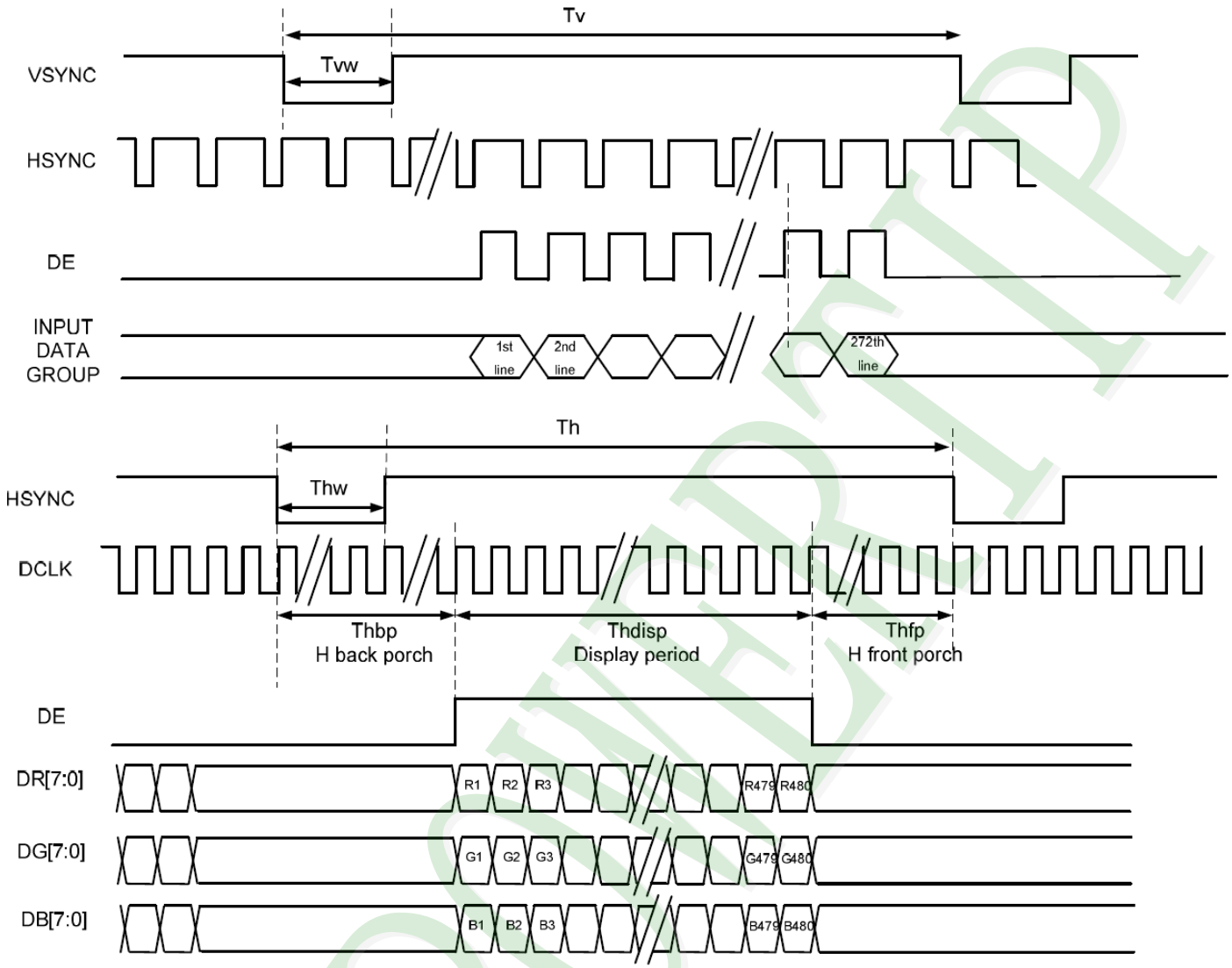
Pin No.	Symbol	Function
21	B0	Blue data bit 0
22	B1	Blue data bit 1
23	B2	Blue data bit 2
24	B3	Blue data bit 3
25	B4	Blue data bit 4
26	B5	Blue data bit 5
27	B6	Blue data bit 6
28	B7	Blue data bit 7
29	GND	Ground
30	CLK	Dot data clock
31	RESETB	Active low global reset signal input.
32	HSYNC	Horizontal sync input
33	VSYNC	Vertical sync input
34	DE	Data input enable. Active High to enable the data input. If not used,please leave it floating.
35	NC	Not Connect.
36	GND	Ground
37	XR	Not Connect.
38	YD	Not Connect.
39	XL	Not Connect.
40	YU	Not Connect.

2.3 Timing Characteristics

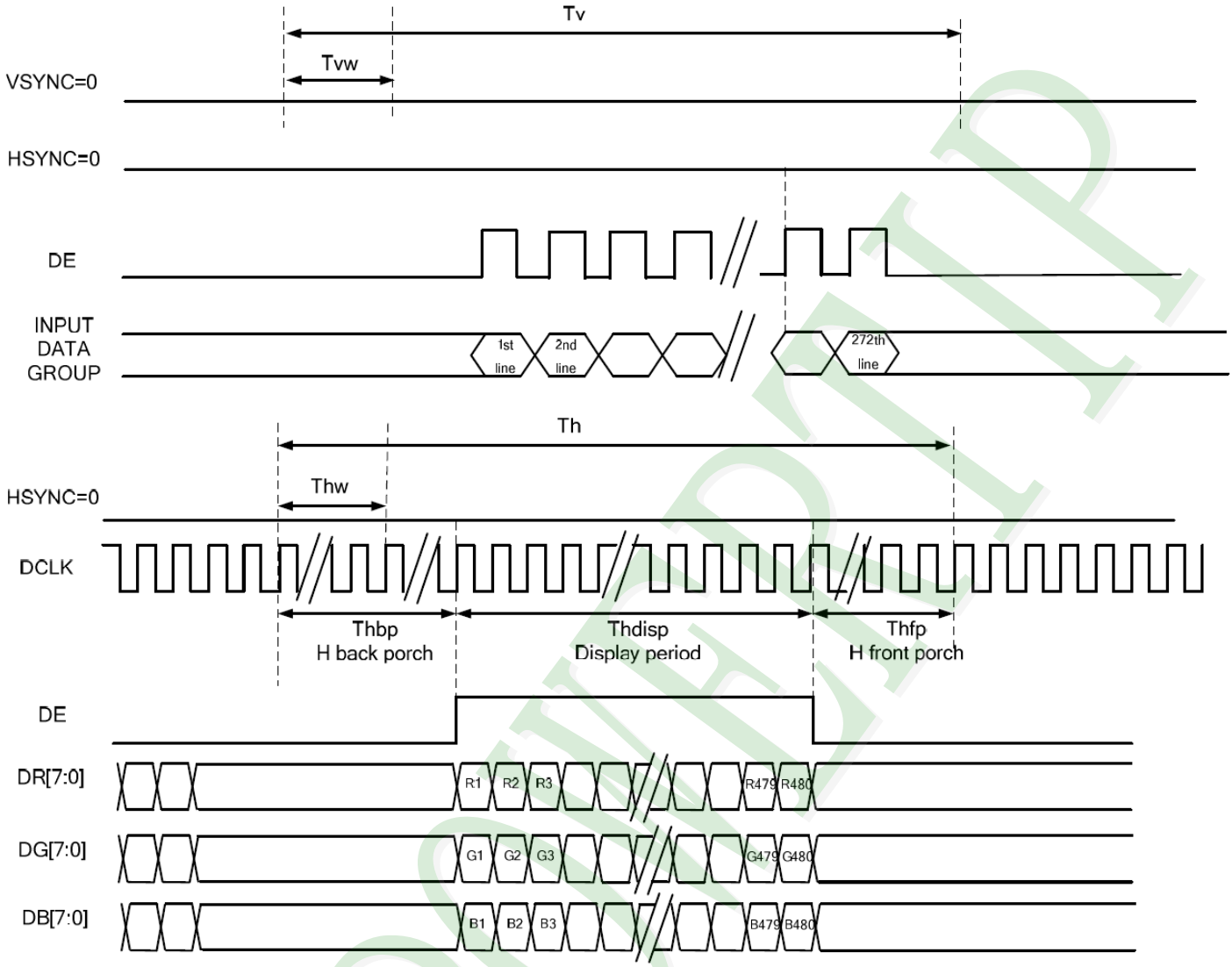
2.3.1 SYNC Mode



2.3.2 SYNC-DE Mode



2.3.3 DE Mode


Tv
Tvw
VSYNC=0
HSYNC=0
DE
INPUT
DATA
GROUP
1st
line
2nd
line
272th
line
Th
Thw
HSYNC=0
DCLK
Thbp
H back porch
Thdisp
Display period
Thfp
H front porch
DE
DR[7:0]
R1
R2
R3
R479
R480
DG[7:0]
G1
G2
G3
G479
G480
DB[7:0]
B1
B2
B3
B479
B480

2.3.4 Parallel 24-bit RGB Input Timing Table

480RGB X 272 Resolution Timing Table							
Item		Symbol	Min.	Typ.	Max.	Unit	Remark
DCLK Frequency		Fclk	8	9	12	MHz	
DCLK Period		Tclk	83	111	125	ns	
HSYNC	Period Time	Th	485	531	598	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	3	43	43	DCLK	By H_Blanking setting
	Front Porch	Thfp	2	8	75	DCLK	
	Pulse Width	Thw	2	4	75	DCLK	
VSYNC	Period Time	Tv	276	292	321	H	
	Display Period	Tvdisp		272		H	
	Back Porch	Tvbp	2	12	12	H	By V_Blanking setting
	Front Porch	Tvfp	2	8	37	H	
	Pulse Width	Tvw	2	4	37	H	

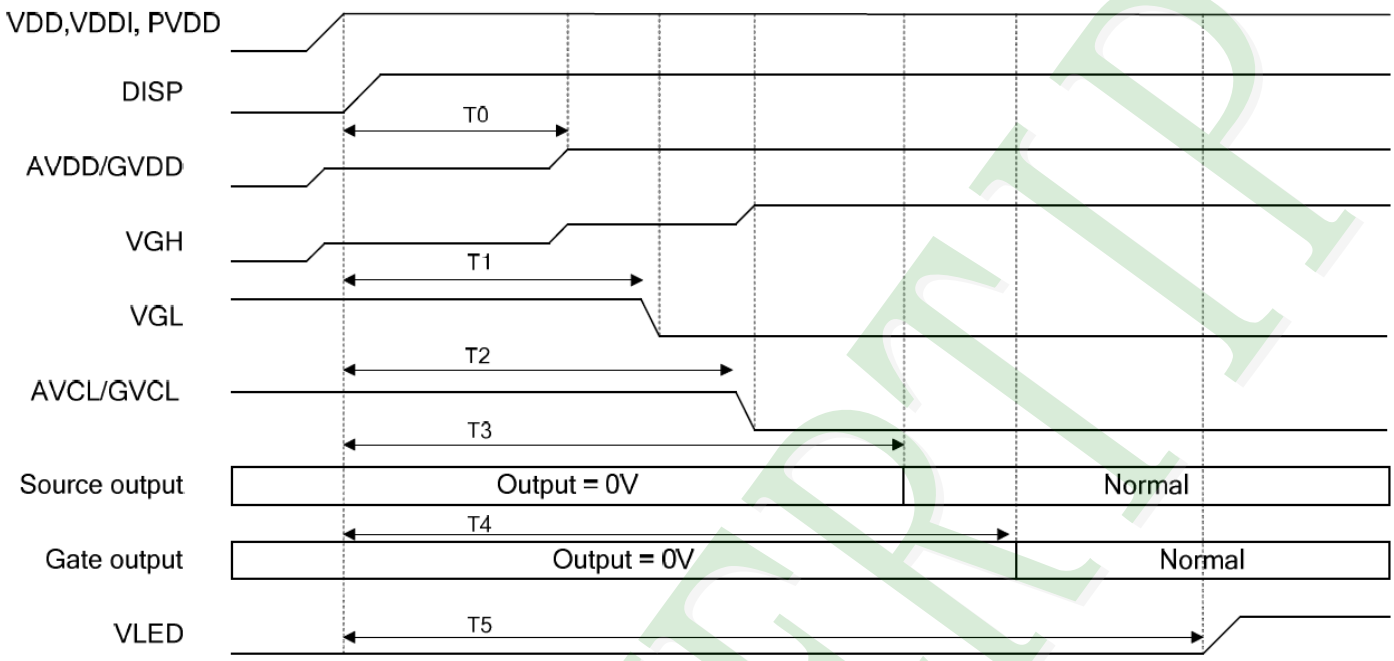
Note: It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

480RGB X 240 Resolution Timing Table							
Item		Symbol	Min.	Typ.	Max.	Unit	Remark
DCLK Frequency		Fclk	8	9	12	MHz	
DCLK Period		Tclk	83	111	125	ns	
HSYNC	Period Time	Th	485	531	598	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	3	43	43	DCLK	By H_Blanking setting
	Front Porch	Thfp	2	8	75	DCLK	
	Pulse Width	Thw	2	4	75	DCLK	
VSYNC	Period Time	Tv	244	260	321	H	
	Display Period	Tvdisp		240		H	
	Back Porch	Tvbp	2	12	12	H	By V_Blanking setting
	Front Porch	Tvfp	2	8	37	H	
	Pulse Width	Tvw	2	4	37	H	

Note: It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

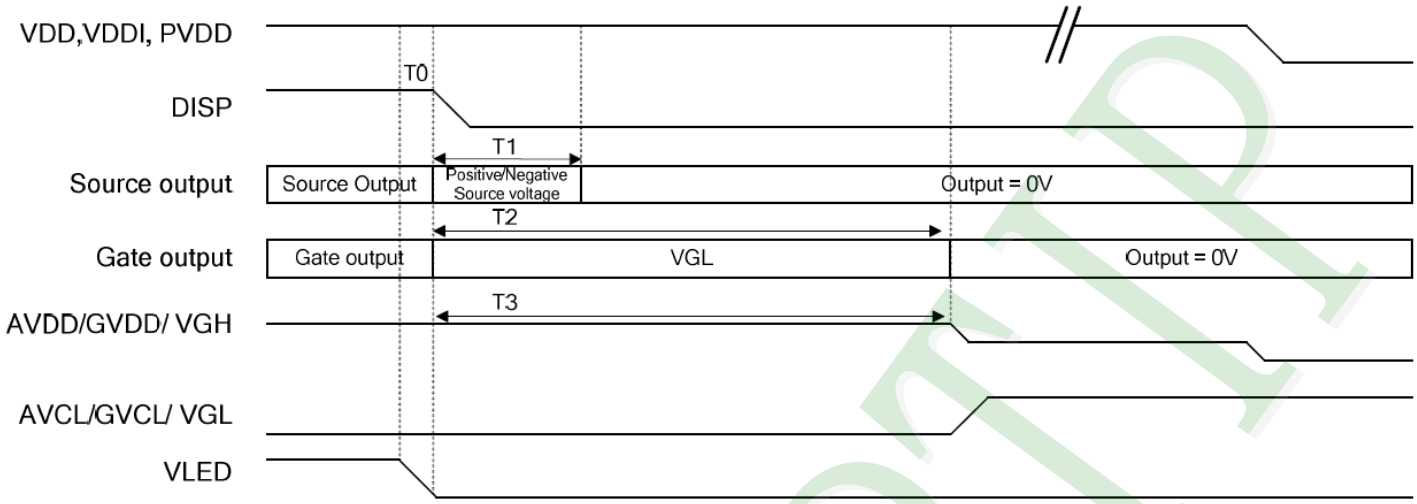
2.3.5 Power Sequence

POWER ON



Symbol	Description	Min. Time	Unit
T0	DISP=”High” to AVDD/GVDD voltage stability	40	ms
T1	DISP=”High” to VGL voltage stability	50	ms
T2	DISP=”High” to AVCL/GVCL stability	70	ms
T3	DISP=”High” to Source output	100	ms
T4	DISP=”High” to Gate output	110	ms
T5	Black Turn on	130	ms

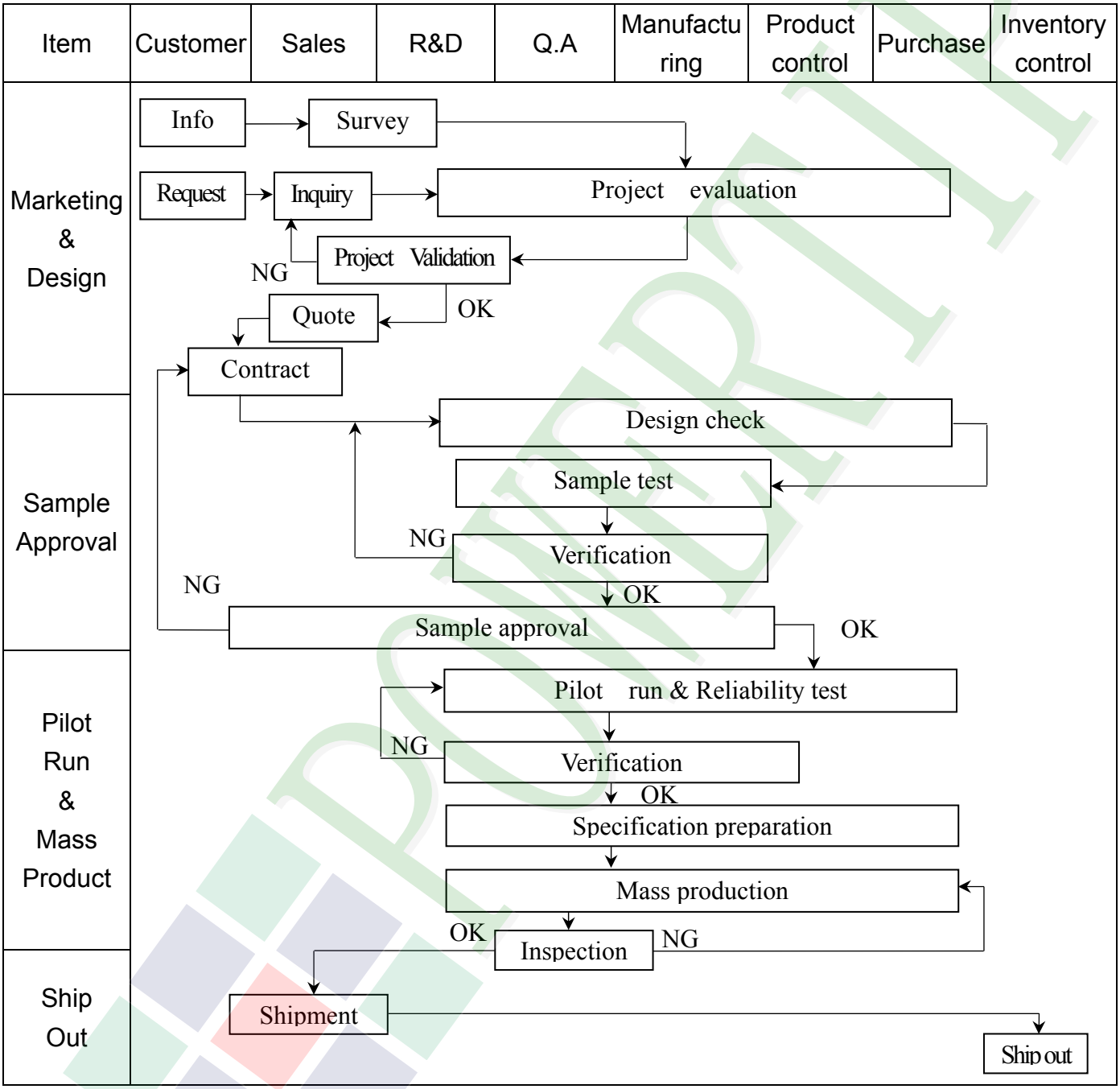
POWER OFF

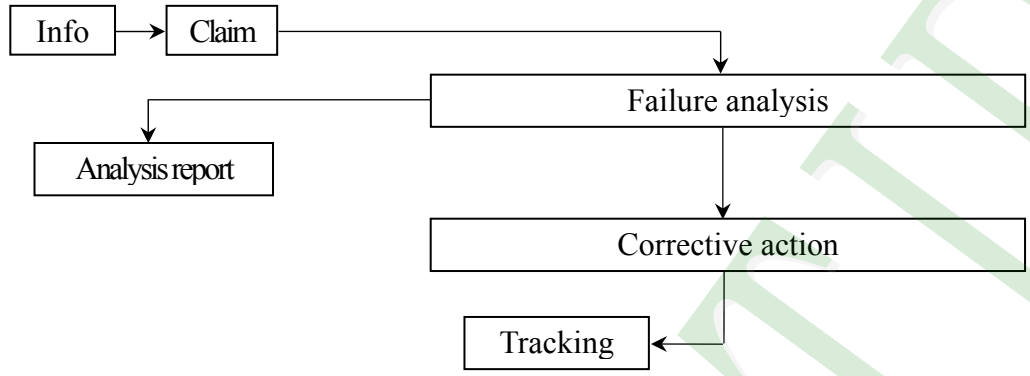


Symbol	Description	Min. Time	Unit
T0	Backlight turn off to DISP=”Low”	5	ms
T1	DISP=”Low” to Source output disable	20	ms
T2	DISP=”Low” to Gate output disable	50	ms
T3	DISP=”Low” to Gate output disable	50	ms

3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service								
Q.A Activity	1. ISO 9001 Maintenance Activities 2. Process improvement proposal 3. Equipment calibration 4. Education And Training Activities 5. Standardization Management							

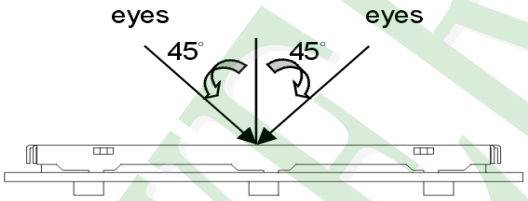
3.2 Inspection Specification

- Scope：The document shall be applied to TFT-LCD Module for 3.5″ ~15″ (Ver.B01).
- Inspection Standard：MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- Equipment：Gauge、MIL-STD、Powertip Tester、Sample
- Defect Level：Major Defect AQL： 0.4 ； Minor Defect AQL： 1.5
- OUT Going Defect Level：Sampling.
- Standard of the product appearance test：

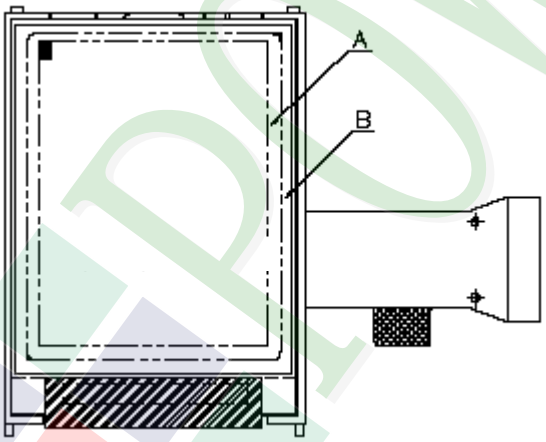
a. Manner of appearance test：

(1). The test best be under 20W×2 fluorescent light，and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

(4). Standard of inspection： (Unit：mm)

◆Specification For TFT-LCD Module 3.5″ ~15″：　(Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="3">01</td><td rowspan="3">Product condition</td><td>1.1The part number is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>1.2 Mixed product types.</td><td>Major</td></tr>
<tr><td>1.3 Assembled in inverse direction.</td><td>Major</td></tr>
<tr><td>02</td><td>Quantity</td><td>2.1The quantity is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>03</td><td>Outline dimension</td><td>3.1 Product dimension and structure must conform to structure diagram.</td><td>Major</td></tr>
<tr><td rowspan="6">04</td><td rowspan="6">Electrical Testing</td><td>4.1 Missing line character and icon.</td><td>Major</td></tr>
<tr><td>4.2 No function or no display.</td><td>Major</td></tr>
<tr><td>4.3 Display malfunction.</td><td>Major</td></tr>
<tr><td>4.4 LCD viewing angle defect.</td><td>Major</td></tr>
<tr><td>4.5 Current consumption exceeds product specifications.</td><td>Major</td></tr>
<tr><td>4.6 Mura can not be seen through 5% ND filter.
(Mura : Under the normal examination angle of view,the picture has the non-uniform phenomenon.)</td><td>Minor</td></tr>
<tr><td>05</td><td>Dot defect

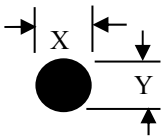
(Bright dot、Dark dot)

On -display</td><td>
<table>
<tr><th colspan="2">Item</th><th>Acceptance (Q’ty)</th></tr>
<tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≦ 4</td></tr>
<tr><td>Dark Dot</td><td>≦ 5</td></tr>
<tr><td>Joint Dot</td><td>≦ 3</td></tr>
<tr><td>Total</td><td>≦ 7</td></tr>
</table>
5.1 Inspection pattern：full white , full black , Red , Green and blue screens.
5.2 It is defined as dot defect if defect area ＞1/2 dot.
5.3 The distance between two dot defect ≧5 mm.
5.4 Bright dot that can not be seen through 5% ND filter.
</td><td>Minor</td></tr>
</table>

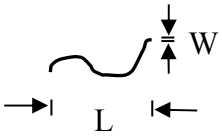
◆Specification For TFT-LCD Module 3.5″ ~15″：

(Ver.B01)

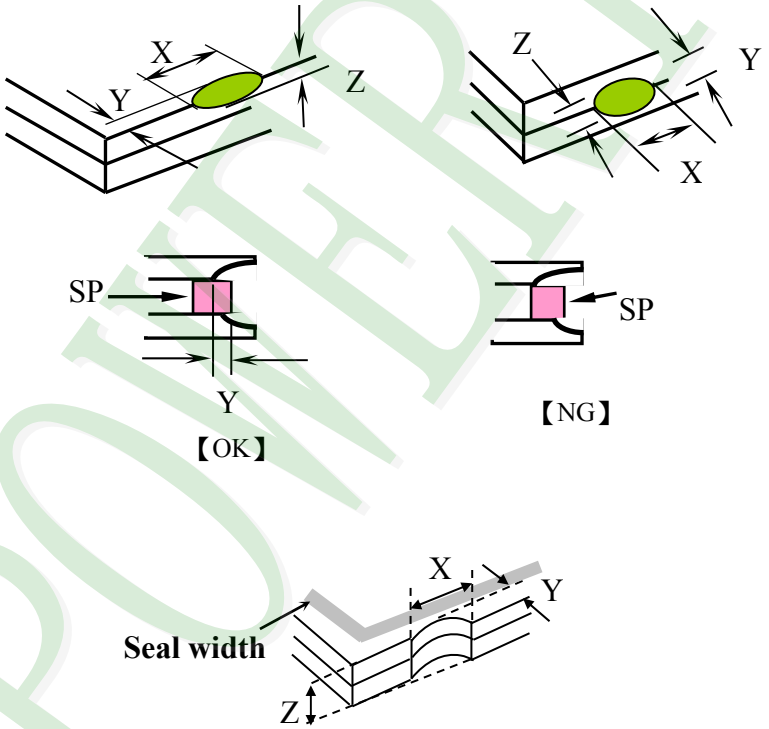
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>06</td><td>Black or white dot、scratch、contamination

Round type
 

Φ＝(x＋y) / 2

Line type
 
</td><td>6.1 Round type (Non-display or display)：
<table>
<tr><th rowspan="2">Dimension (diameter：Φ)</th><th colspan="2">Acceptance (Q’ty)</th></tr>
<tr><th>A area</th><th>B area</th></tr>
<tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="4">Ignore</td></tr>
<tr><td>0.25 ＜ Φ ≦ 0.50</td><td>5</td></tr>
<tr><td>Φ ＞ 0.50</td><td>0</td></tr>
<tr><td>Total</td><td>5</td></tr>
</table>
6.2 Line type(Non-display or display)：
<table>
<tr><th rowspan="2">module size</th><th rowspan="2">Length (L)</th><th rowspan="2">Width (W)</th><th colspan="2">Acceptance (Q’ty)</th></tr>
<tr><th>A area</th><th>B area</th></tr>
<tr><td rowspan="5">3.5” to less 9”</td><td>---</td><td>W ≦ 0.03</td><td>Ignore</td><td rowspan="5">Ignore</td></tr>
<tr><td>L ≦10.0</td><td>0.03 ＜W ≦ 0.05</td><td>4</td></tr>
<tr><td>L ≦5.0</td><td>0.05 ＜W ≦ 0.10</td><td>2</td></tr>
<tr><td>---</td><td>W ＞0.10</td><td>As round type</td></tr>
<tr><td colspan="2">Total</td><td>5</td></tr>
<tr><td rowspan="4">9” to 15”</td><td>---</td><td>W ≦ 0.05</td><td>Ignore</td><td rowspan="4">Ignore</td></tr>
<tr><td>L ≦10.0</td><td>0.05 ＜W ≦ 0.10</td><td>5</td></tr>
<tr><td>---</td><td>W ＞0.10</td><td>As round type</td></tr>
<tr><td colspan="2">Total</td><td>5</td></tr>
</table></td><td>Minor</td></tr>
<tr><td>07</td><td>Polarizer Bubble</td><td>
<table>
<tr><th rowspan="2">Dimension (diameter：Φ)</th><th colspan="2">Acceptance (Q’ty)</th></tr>
<tr><th>A area</th><th>B area</th></tr>
<tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="5">Ignore</td></tr>
<tr><td>0.25 ＜ Φ ≦ 0.50</td><td>4</td></tr>
<tr><td>0.50 ＜ Φ ≦ 0.80</td><td>1</td></tr>
<tr><td>Φ ＞ 0.80</td><td>0</td></tr>
<tr><td>Total</td><td>5</td></tr>
</table></td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~15″ : (Ver.B01)

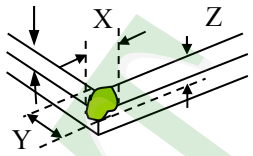
NO	Item	Criterion	Level
08	The crack of glass	Symbols : X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length 8.1 General glass chip : 8.1.1 Chip on panel surface and crack between panels:  	Minor

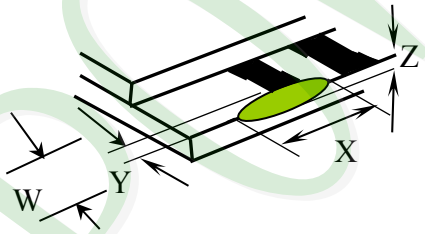
X	Y	Z
≦ a	Crack can't enter viewing area	≦1/2 t
≦ a	Crack can't exceed the half of SP width.	1/2 t < Z ≦2 t

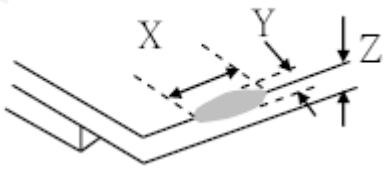
◆Specification For TFT-LCD Module 3.5″ ~15″ : (Ver.B01)

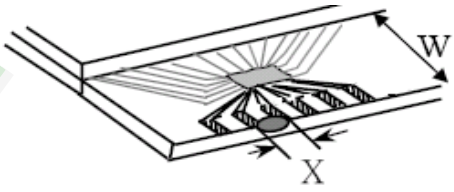
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="2">08</td><td rowspan="2">The crack of glass</td><td>
Symbols :

X : The length of crack　　Y : The width of crack.
Z : The thickness of crack　　W : terminal length
t : The thickness of glass　　a : LCD side length

8.1.2 Corner crack :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦1/5 a</td><td>Crack can’t enter viewing area</td><td>Z ≦ 1/2 t</td></tr>
<tr><td>≦1/5 a</td><td>Crack can’t exceed the half of SP width.</td><td>1/2 t ＜ Z ≦ 2 t</td></tr>
</table>
</td><td rowspan="2">Minor</td></tr>
<tr><td>
8.2 Protrusion over terminal :
8.2.1 Chip on electrode pad :




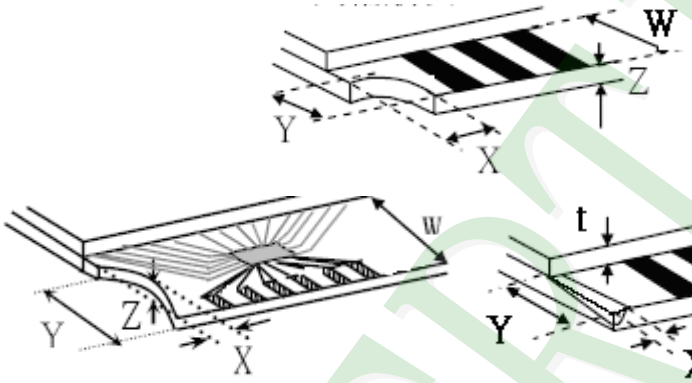


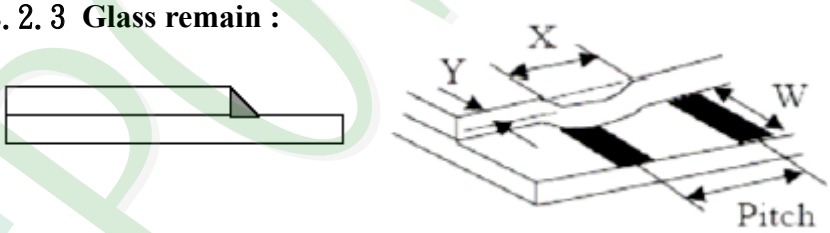
<table>
<tr><th></th><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>Front</td><td>≦ a</td><td>≦ 1/2 W</td><td>≦ t</td></tr>
<tr><td>Back</td><td>≦ a</td><td>≦ W</td><td>≦ 1/2 t</td></tr>
</table>
</td></tr>
</table>

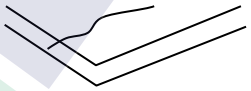
◆Specification For TFT-LCD Module 3.5″ ~15″ : (Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>08</td><td>The crack of glass</td><td>
Symbols :

X : The length of crack Y : The width of crack.
Z : The thickness of crack W : terminal length
t : The thickness of glass a : LCD side length

8.2.2 Non-conductive portion :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ 1/3 a</td><td>≦ W</td><td>≦t</td></tr>
</table>
⊙ If the chipped area touches the ITO terminal, over 2/3 of
● the ITO must remain and be inspected according to electrode terminal specifications.
8.2.3 Glass remain :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ a</td><td>≦ 1/3 W</td><td>≦t</td></tr>
</table>
8.2.4 Cracking

Not Allowed
</td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~15″ : (Ver.B01)

NO	Item	Criterion	Level
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
10	General appearance	10.1 Pin type、quantity、dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC .	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≦1.5 mm.	Minor

4. RELIABILITY TEST

4.1 Reliability Test Condition (Ver.B01)

<table>
<tr><th>NO.</th><th>TEST ITEM</th><th>TEST CONDITION</th></tr>
<tr><td>1</td><td>High Temperature Storage Test</td><td>Keep in +80 ±2℃ 240 hrs
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>2</td><td>Low Temperature Storage Test</td><td>Keep in -30 ±2℃ 240 hrs
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>3</td><td>High Temperature / High Humidity Storage Test</td><td>Keep in +60 ℃ / 90% R.H duration for 240 hrs
Surrounding temperature, then storage at normal condition 4hrs.
(Excluding the polarizer)</td></tr>
<tr><td>4</td><td>Temperature Cycling Storage Test</td><td>-30℃ → +25℃ → +80℃ → +25℃
(30mins) (5mins) (30mins) (5mins)
20 Cycle
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td rowspan="2">5</td><td rowspan="2">ESD Test</td><td>Air Discharge:
Apply 2 KV with 5 times
Discharge for each polarity +/-
Contact Discharge:
Apply 250 V with 5 times
discharge for each polarity +/-</td></tr>
<tr><td>1. Temperature ambiance : 15℃～35℃
2. Humidity relative : 30%～60%
3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%
4. Discharge Resistance(Rd) : 330Ω±10%
5. Discharge, mode of operation :
Single Discharge (time between successive discharges at least 1 sec)
(Tolerance if the output voltage indication : ±5%)</td></tr>
<tr><td>6</td><td>Vibration Test (Packaged)</td><td>1. Sine wave 10～55 Hz frequency (1 min/sweep)
2. The amplitude of vibration :1.5 mm
3. Each direction (X、Y、Z) duration for 2 Hrs</td></tr>
<tr><td>7</td><td>Drop Test (Packaged)</td><td><table><tr><th>Packing Weight (Kg)</th><th>Drop Height (cm)</th></tr><tr><td>0 ~ 45.4</td><td>122</td></tr><tr><td>45.4 ~ 90.8</td><td>76</td></tr><tr><td>90.8 ~ 454</td><td>61</td></tr><tr><td>Over 454</td><td>46</td></tr></table>Drop Direction :※1 corner / 3 edges / 6 sides each 1time</td></tr>
</table>

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.

5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

5.2.1 Avoid any strong mechanical shock which can break the glass.

5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.

5.2.3 Do not remove the panel or frame from the module.

5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)

5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.

5.2.6 Do not touch the display area with bare hands , this will stain the display area.

5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.2.8 To control temperature and time of soldering is 320±10℃and 3-5 sec.

5.2.9 To avoid liquid (include organic solvent) stained on LCM .

5.2.10 Caution!(LCM products with Capacitive Touch Panel)

Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).

Therefore, the touch needs to be thoroughly tested inside the target application.

5.3 STORAGE

5.3.1 Store the panel or module in a dark place where the temperature is 25℃ ±5℃ and the humidity is below 65% RH.

5.3.2 Do not place the module near organics solvents or corrosive gases.

5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

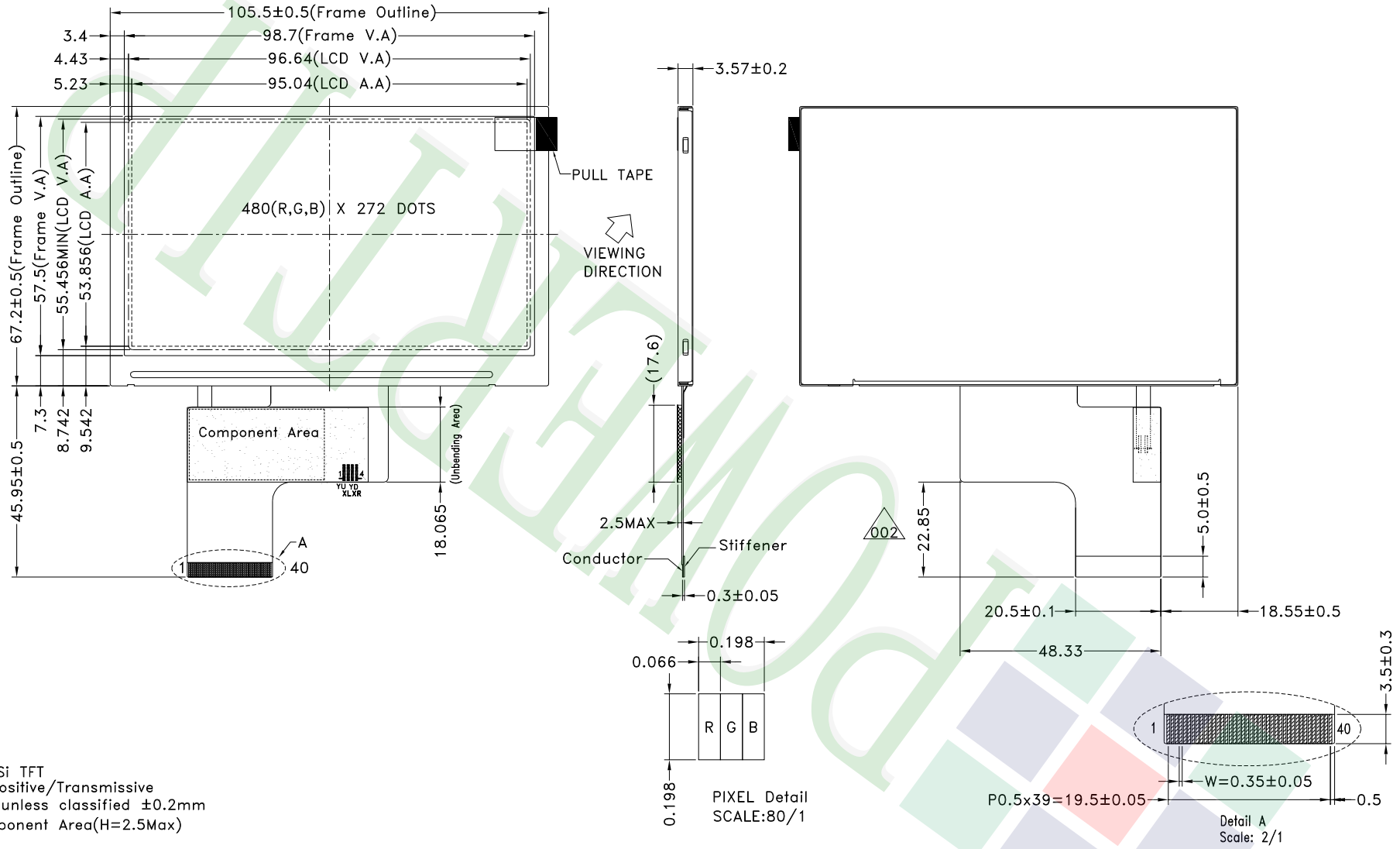
5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security

systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



NOTES:

1.LCD TYPE: a-Si TFT
2.LCD DISPLAY:Positive/Transmissive
3.The tolerance unless classified ±0.2mm
4. FPC Component Area(H=2.5Max)
   Shield tape
5.FPC suggested connector : (ENTERY)6701K-E40N-00L or compatible

REV	REV BY	REVISER	DATE
007			
006			
005			
004			
003			
002	Momdify FPC	Sally	2019/04/10
001	NEW DRAWING	Sally	2019/01/23

PART NO: PH480272T005-IBA03

DRAWING NAME : JLMD-PH480272T005-IBA03

TITLE: LCD Module Drawing

久正光電股份有限公司
POWERTIP TECHNOLOGY CORPORATION

Design	Sally	(3)	Surface		
Check	Terry	Unit	MM	Material	
Approve	Ryan	Scale	1:1	Thickness	
		Page	1/1	Quantity	

公差等級 / 最小長度 (mm)	精級
1 ~ 4	-
4 ~ 16	-
16 ~ 63	-
63 ~ 250	-
250 ~ 1000	-

PT-A-054-01

Ver.001

Documents NO.	JPKG-PH480272T005-IBA03

LCM包裝規格書
LCM Packaging Specifications
(For Tray)

Approve	Check	Contact
Ryan	Terry	Sally

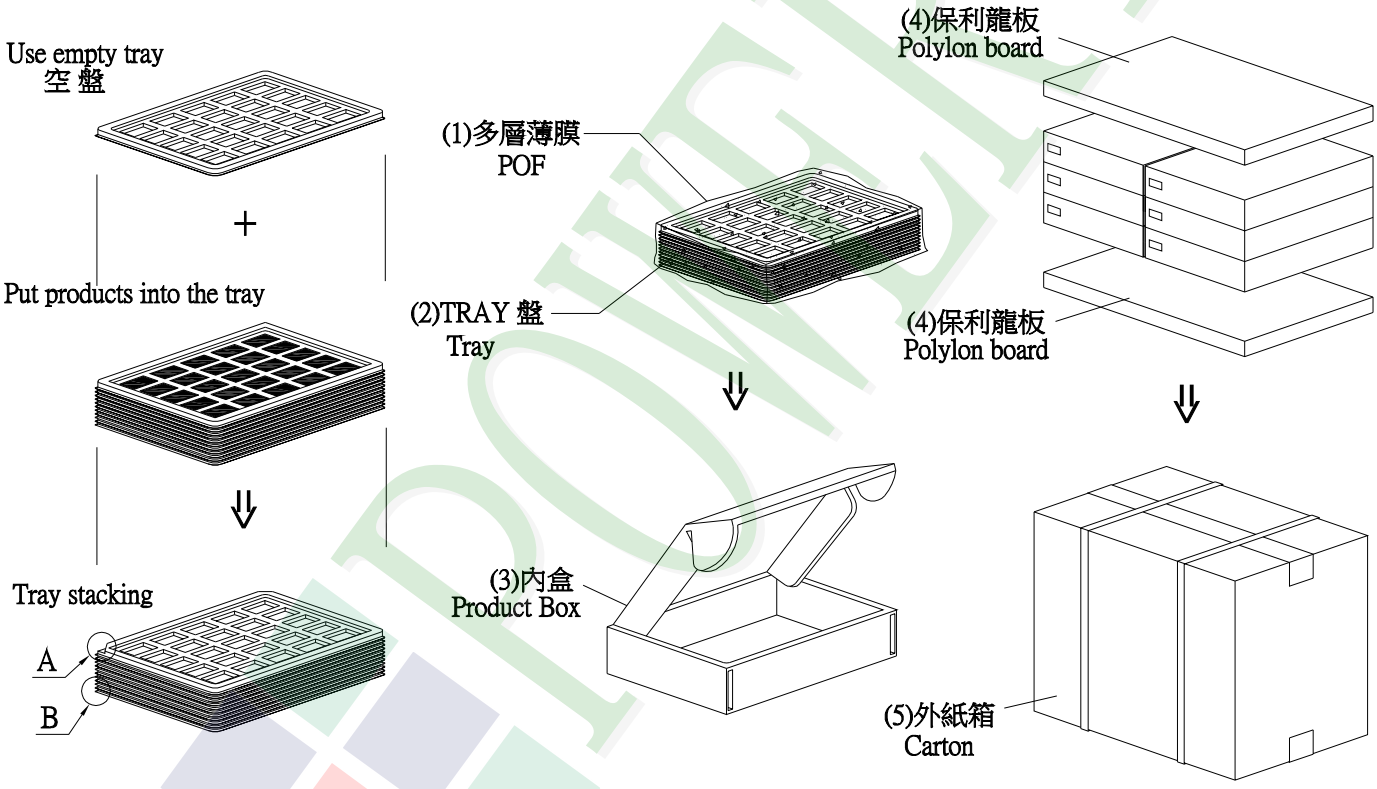
1.包裝材料規格表 (Packaging Material) : (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH480272T005-IBA03	105.5 X 67.2 X 3.57	0.05	144	7.2
2	多層薄膜(1)POF	OTFILM0BA03ABA	19"X350X0.015	——	6	——
3	TRAY 盤 (2)Tray	TYSG000000202	352 X 260 X 13.05	0.1	42	4.2
4	內盒(3)Product Box	BX36627063ABBA	383 X 270 X 66	0.182	6	1.092
5	保利龍板(4)Polylon board	OTPLB00PL08ABA	550 X 393 X 20	0.0284	2	0.0568
6	外紙箱(5)Carton	BX57041027CCBA	570 X 410 X 265	1.0	1	1.0
7						
8						
9						

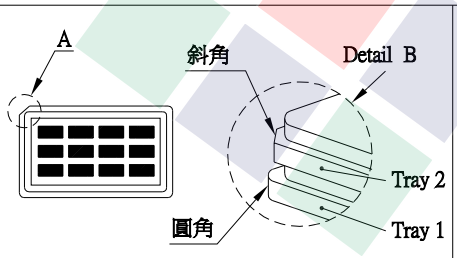
2.一 整箱總重量 (Total LCD Weight in carton) : 13.55 Kg±10%

3.單箱數量規格表 (Packaging Specifications and Quantity) :

(1)LCM quantity per box : no per tray	4	x no of tray	6	=	24
(2)Total LCM quantity in carton : quantity per box	24	x no of boxes	6	=	144



特 記 事 項 (REMARK)



4.TRAY盤相疊時,需旋轉180度,請詳見B視圖
Rotate tray 180 degrees and place on top of stack.
Check the tray stack using Fig. B.